

BCP51; BCX51; BC51PA

45 V, 1 A PNP medium power transistors

Rev. 9 — 13 October 2011

Product data sheet

1. Product profile

1.1 General description

PNP medium power transistor series in Surface-Mounted Device (SMD) plastic packages.

Table 1. Product overview

| Type number ^[1] | Package | | | NPN complement |
|----------------------------|----------|-------|--------|----------------|
| | Nexperia | JEITA | JEDEC | |
| BCP51 | SOT223 | SC-73 | - | BCP54 |
| BCX51 | SOT89 | SC-62 | TO-243 | BCX54 |
| BC51PA | SOT1061 | - | - | BC54PA |

[1] Valid for all available selection groups.

1.2 Features and benefits

- High current
- Three current gain selections
- High power dissipation capability
- Exposed heatsink for excellent thermal and electrical conductivity (SOT89, SOT1061)
- Leadless very small SMD plastic package with medium power capability (SOT1061)
- AEC-Q101 qualified

1.3 Applications

- Linear voltage regulators
- High-side switches
- Battery-driven devices
- Power management
- MOSFET drivers
- Amplifiers

1.4 Quick reference data

Table 2. Quick reference data

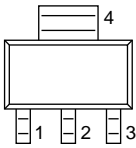
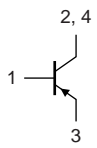
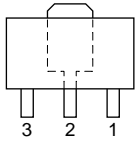
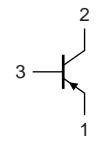
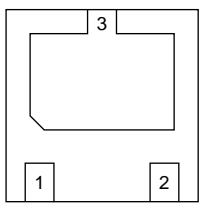
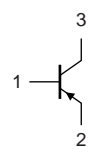
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-----------|---------------------------|-------------------------------|-----|-----|-----|------|
| V_{CE0} | collector-emitter voltage | open base | - | - | -45 | V |
| I_C | collector current | | - | - | -1 | A |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1$ ms | - | - | -2 | A |

Table 2. Quick reference data ...continued

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------|------------------------|---------------------------------------------------|-----|-----|-----|------|
| h_{FE} | DC current gain | $V_{CE} = -2\text{ V};$ $I_C = -150\text{ mA}$ | 63 | - | 250 | |
| | h_{FE} selection -10 | $V_{CE} = -2\text{ V};$ $I_C = -150\text{ mA}$ | 63 | - | 160 | |
| | h_{FE} selection -16 | $V_{CE} = -2\text{ V};$ $I_C = -150\text{ mA}$ | 100 | - | 250 | |

2. Pinning information

Table 3. Pinning

| Pin | Description | Simplified outline | Graphic symbol |
|----------------|-------------|--------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------|
| SOT223 | | | |
| 1 | base |  |  sym028 |
| 2 | collector | | |
| 3 | emitter | | |
| 4 | collector | | |
| SOT89 | | | |
| 1 | emitter |  |  006aaa231 |
| 2 | collector | | |
| 3 | base | | |
| SOT1061 | | | |
| 1 | base |  Transparent top view |  sym013 |
| 2 | emitter | | |
| 3 | collector | | |

3. Ordering information

Table 4. Ordering information

| Type number ^[1] | Package | | |
|----------------------------|---------|--------------------------------------------------------------------------------------------------------|---------|
| | Name | Description | Version |
| BCP51 | SC-73 | plastic surface-mounted package with increased heatsink; 4 leads | SOT223 |
| BCX51 | SC-62 | plastic surface-mounted package; collector pad for good heat transfer; 3 leads | SOT89 |
| BC51PA | HUSON3 | plastic thermal enhanced ultra thin small outline package; no leads; 3 terminals; body 2 × 2 × 0.65 mm | SOT1061 |

[1] Valid for all available selection groups.

4. Marking

Table 5. Marking codes

| Type number | Marking code |
|-------------|--------------|
| BCP51 | BCP51 |
| BCP51-10 | BCP51/10 |
| BCP51-16 | BCP51/16 |
| BCX51 | AA |
| BCX51-10 | AC |
| BCX51-16 | AD |
| BC51PA | BP |
| BC51-10PA | BQ |
| BC51-16PA | BR |

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit | | | |
|-----------|---------------------------|----------------------------------|-----------|----------------------|------|------|------|----|
| V_{CBO} | collector-base voltage | open emitter | - | -45 | V | | | |
| V_{CEO} | collector-emitter voltage | open base | - | -45 | V | | | |
| V_{EBO} | emitter-base voltage | open collector | - | -5 | V | | | |
| I_C | collector current | | - | -1 | A | | | |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1$ ms | - | -2 | A | | | |
| I_B | base current | | - | -0.3 | A | | | |
| I_{BM} | peak base current | single pulse; $t_p \leq 1$ ms | - | -0.3 | A | | | |
| P_{tot} | total power dissipation | $T_{amb} \leq 25$ °C | | | | | | |
| | | | BCP51 | [1] | - | 0.65 | W | |
| | | | | [2] | - | 1.00 | W | |
| | | | | [3] | - | 1.35 | W | |
| | | | BCX51 | [1] | - | 0.50 | W | |
| | | | | [2] | - | 0.95 | W | |
| | | | | [3] | - | 1.35 | W | |
| | | | BC51PA | [1] | - | 0.42 | W | |
| | | | | [2] | - | 0.83 | W | |
| | | | | [3] | - | 1.10 | W | |
| | | | | [4] | - | 0.81 | W | |
| | | | | [5] | - | 1.65 | W | |
| | | | T_j | junction temperature | | - | 150 | °C |
| | | | T_{amb} | ambient temperature | | -55 | +150 | °C |
| | | | T_{stg} | storage temperature | | -65 | +150 | °C |

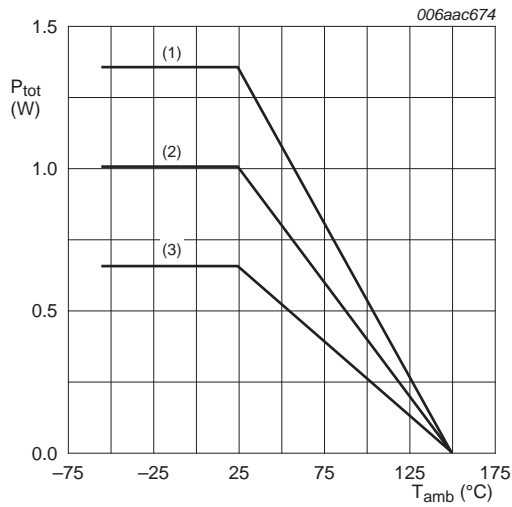
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

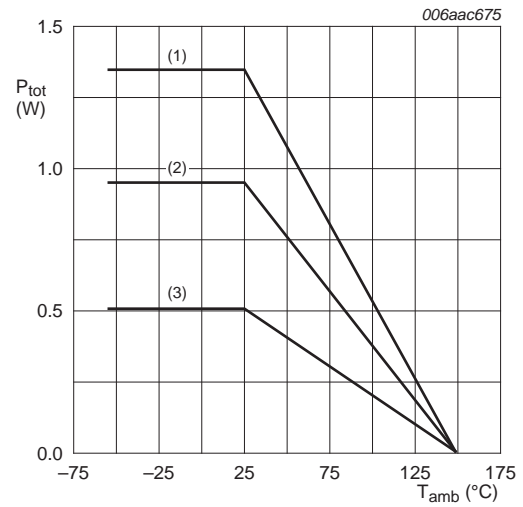
[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[5] Device mounted on an FR4 PCB, 4-layer copper, tin-plated, mounting pad for collector 1 cm².



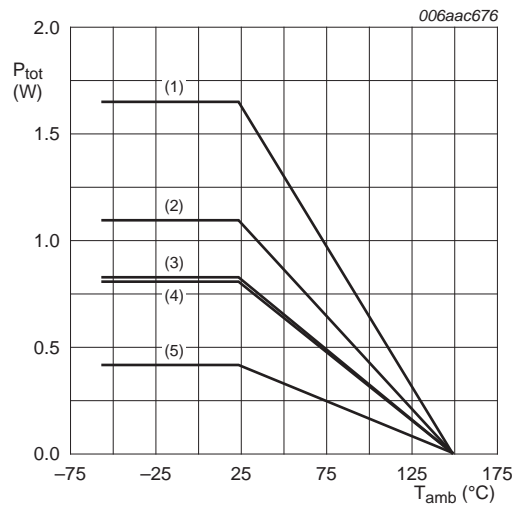
- (1) FR4 PCB, mounting pad for collector 6 cm²
- (2) FR4 PCB, mounting pad for collector 1 cm²
- (3) FR4 PCB, standard footprint

Fig 1. Power derating curves SOT223



- (1) FR4 PCB, mounting pad for collector 6 cm²
- (2) FR4 PCB, mounting pad for collector 1 cm²
- (3) FR4 PCB, standard footprint

Fig 2. Power derating curves SOT89



- (1) FR4 PCB, 4-layer copper, mounting pad for collector 1 cm²
- (2) FR4 PCB, single-sided copper, mounting pad for collector 6 cm²
- (3) FR4 PCB, single-sided copper, mounting pad for collector 1 cm²
- (4) FR4 PCB, 4-layer copper, standard footprint
- (5) FR4 PCB, single-sided copper, standard footprint

Fig 3. Power derating curves SOT1061

6. Thermal characteristics

Table 7. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | | | | | | | |
|---------------|---------------------------------------------|--------------------------------------------------|--------|-----|-----|------|-----|-----|--------|---|---|----|-----|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | BCP51 | [1] | - | - | 192 | K/W | | | | | |
| | | | | [2] | - | - | 125 | K/W | | | | | |
| | | | | [3] | - | - | 93 | K/W | | | | | |
| | | | BCX51 | [1] | - | - | 250 | K/W | | | | | |
| | | | | [2] | - | - | 132 | K/W | | | | | |
| | | | | [3] | - | - | 93 | K/W | | | | | |
| | | | BC51PA | [1] | - | - | 298 | K/W | | | | | |
| | | | | [2] | - | - | 151 | K/W | | | | | |
| | | | | [3] | - | - | 114 | K/W | | | | | |
| | [4] | - | | - | 154 | K/W | | | | | | | |
| | [5] | - | | - | 76 | K/W | | | | | | | |
| | $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | | | | | | | | | | |
| | | | | | | | | | BCP51 | - | - | 16 | K/W |
| | | | | | | | | | BCX51 | - | - | 16 | K/W |
| | | | | | | | | | BC51PA | - | - | 20 | K/W |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[5] Device mounted on an FR4 PCB, 4-layer copper, tin-plated, mounting pad for collector 1 cm².



FR4 PCB, standard footprint

Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT223; typical values



FR4 PCB, mounting pad for collector 1 cm²

Fig 5. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT223; typical values



FR4 PCB, mounting pad for collector 6 cm²

Fig 6. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT223; typical values



FR4 PCB, standard footprint

Fig 7. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT89; typical values



Fig 8. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT89; typical values

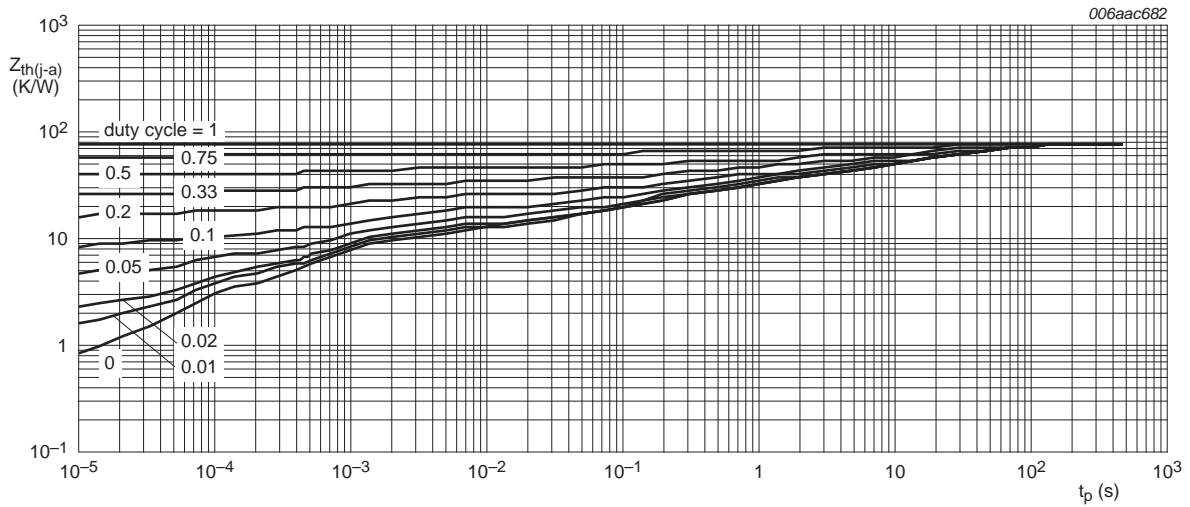
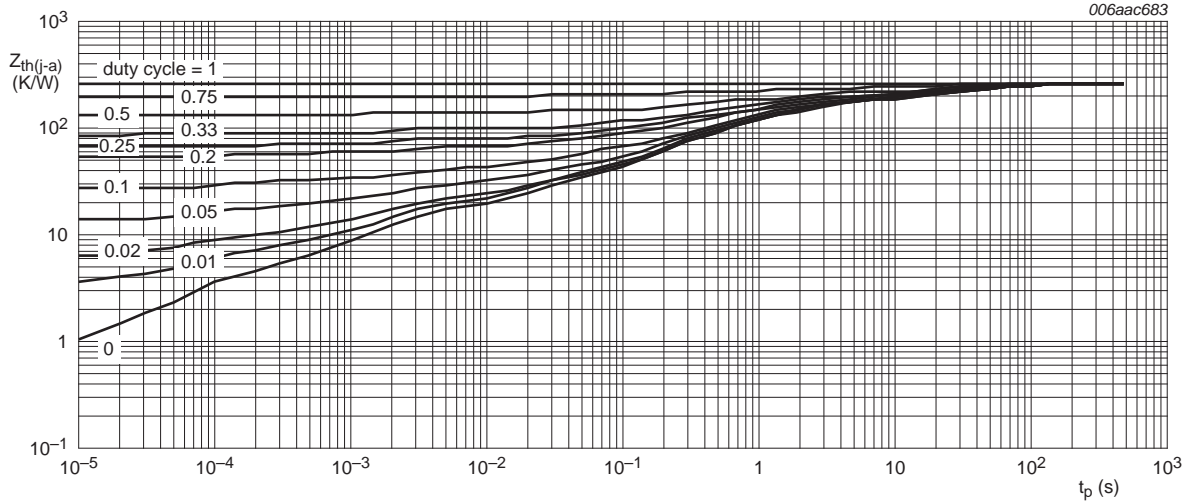
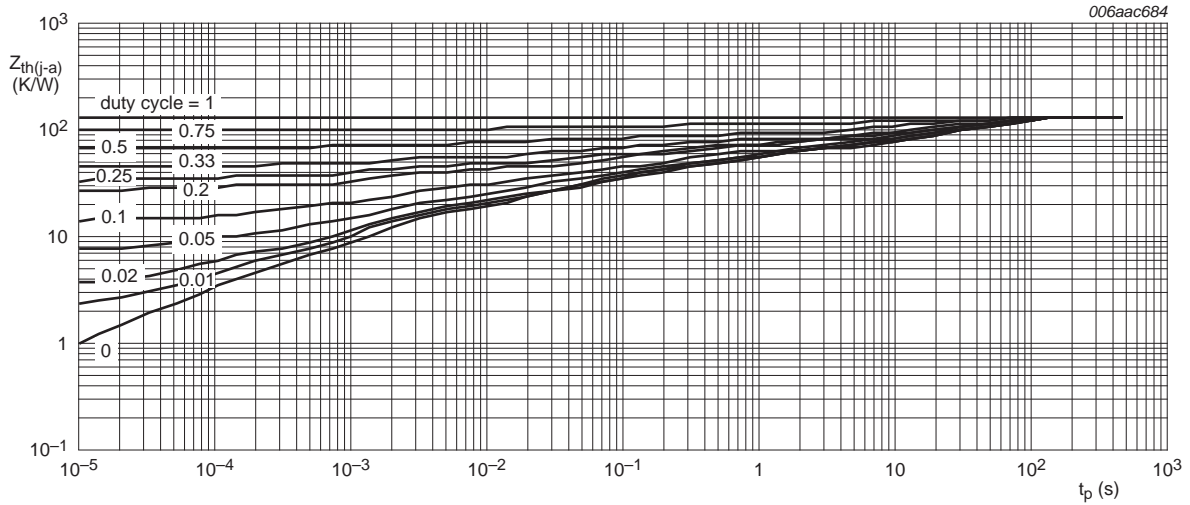


Fig 9. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT89; typical values



FR4 PCB, single-sided copper, standard footprint

Fig 10. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT1061; typical values



FR4 PCB, single-sided copper, mounting pad for collector 1 cm²

Fig 11. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT1061; typical values



FR4 PCB, single-sided copper, mounting pad for collector 6 cm²

Fig 12. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT1061; typical values



FR4 PCB, 4-layer copper, standard footprint

Fig 13. Transient thermal impedance from junction to ambient as a function of pulse duration for SOT1061; typical values



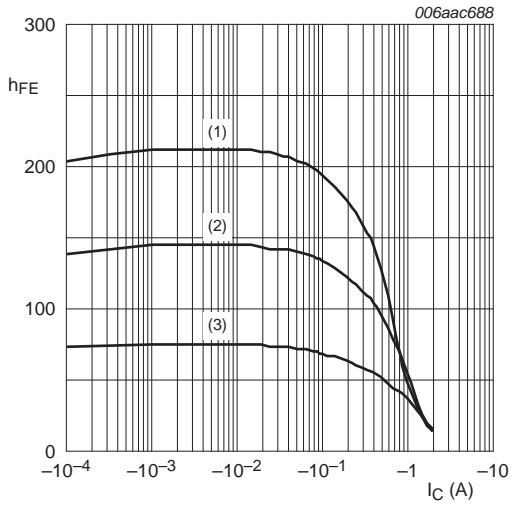
7. Characteristics

Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified.

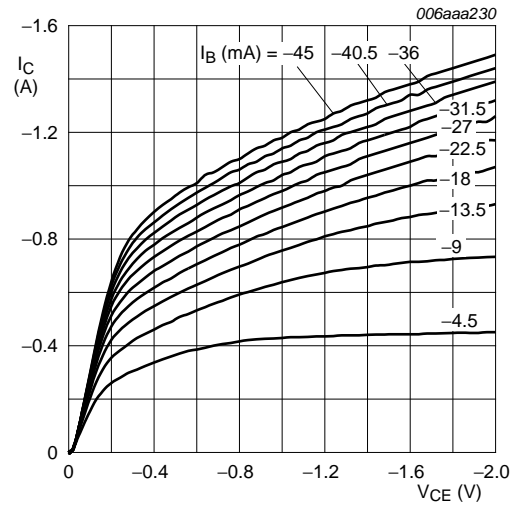
| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------|--------------------------------------|---------------------------------------------------------------------------|--------|-----|------|------|
| I _{CBO} | collector-base cut-off current | V _{CB} = -30 V; I _E = 0 A | - | - | -100 | nA |
| | | V _{CB} = -30 V; I _E = 0 A; T _j = 150 °C | - | - | -10 | μA |
| I _{EBO} | emitter-base cut-off current | V _{EB} = -5 V; I _C = 0 A | - | - | -100 | nA |
| h _{FE} | DC current gain | V _{CE} = -2 V | | | | |
| | | I _C = -5 mA | 63 | - | - | |
| | | I _C = -150 mA | 63 | - | 250 | |
| | | I _C = -500 mA | [1] 40 | - | - | |
| | DC current gain | V _{CE} = -2 V | | | | |
| | h _{FE} selection -10 | I _C = -150 mA | 63 | - | 160 | |
| | h _{FE} selection -16 | I _C = -150 mA | 100 | - | 250 | |
| V _{CEsat} | collector-emitter saturation voltage | I _C = -500 mA; I _B = -50 mA | [1] - | - | -0.5 | V |
| V _{BE} | base-emitter voltage | V _{CE} = -2 V; I _C = -500 mA | [1] - | - | -1 | V |
| C _C | collector capacitance | V _{CB} = -10 V; I _E = i _e = 0 A; f = 1 MHz | - | 15 | - | pF |
| f _T | transition frequency | V _{CE} = -5 V; I _C = -50 mA; f = 100 MHz | - | 145 | - | MHz |

[1] Pulse test: t_p ≤ 300 μs; δ = 0.02.



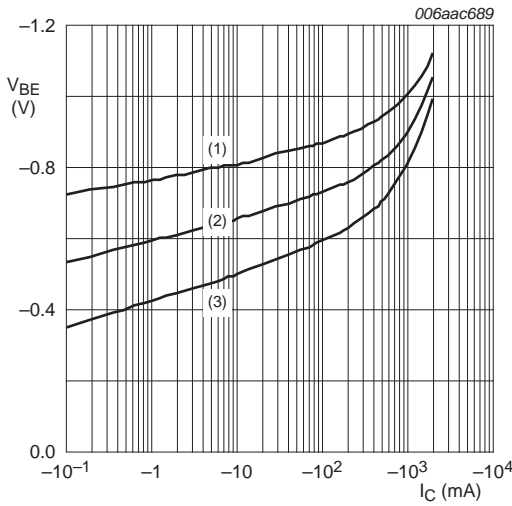
$V_{CE} = -2\text{ V}$
 (1) $T_{amb} = 100\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = -55\text{ }^{\circ}\text{C}$

Fig 15. DC current gain as a function of collector current; typical values



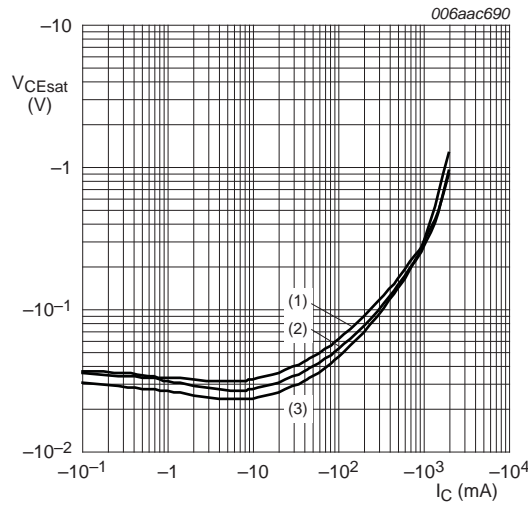
$T_{amb} = 25\text{ }^{\circ}\text{C}$

Fig 16. Collector current as a function of collector-emitter voltage; typical values



$V_{CE} = -2\text{ V}$
 (1) $T_{amb} = -55\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = 100\text{ }^{\circ}\text{C}$

Fig 17. Base-emitter voltage as a function of collector current; typical values



$I_C/I_B = 10$
 (1) $T_{amb} = 100\text{ }^{\circ}\text{C}$
 (2) $T_{amb} = 25\text{ }^{\circ}\text{C}$
 (3) $T_{amb} = -55\text{ }^{\circ}\text{C}$

Fig 18. Collector-emitter saturation voltage as a function of collector current; typical values

8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline

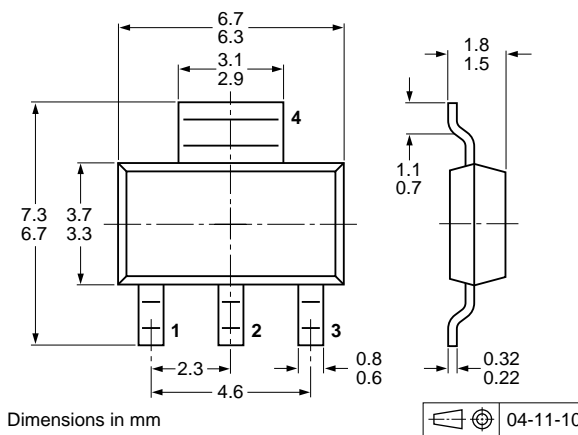


Fig 19. Package outline SOT223 (SC-73)

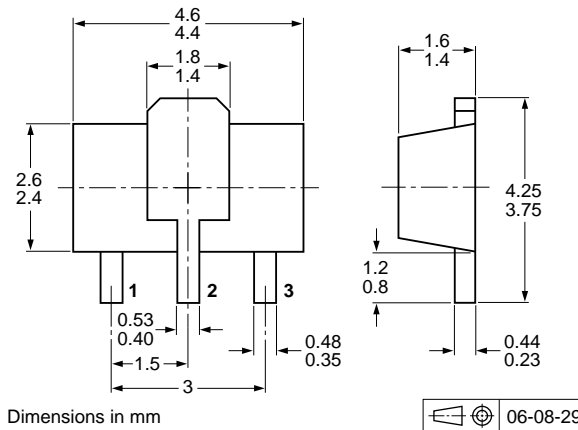


Fig 20. Package outline SOT89 (SC-62/TO-243)



Fig 21. Package outline SOT1061 (HUSON3)

10. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.^[1]

| Type number ^[2] | Package | Description | Packing quantity | | |
|----------------------------|---------|----------------------------------------------------|------------------|------|------|
| | | | 1000 | 3000 | 4000 |
| BCP51 | SOT223 | 8 mm pitch, 12 mm tape and reel | -115 | - | -135 |
| BCX51 | SOT89 | 8 mm pitch, 12 mm tape and reel; T1 ^[3] | -115 | - | -135 |
| | | 8 mm pitch, 12 mm tape and reel; T3 ^[4] | -146 | - | - |
| BC51PA | SOT1061 | 4 mm pitch, 8 mm tape and reel | - | -115 | - |

[1] For further information and the availability of packing methods, see [Section 14](#).

[2] Valid for all available selection groups.

[3] T1: normal taping

[4] T3: 90° rotated taping

11. Soldering

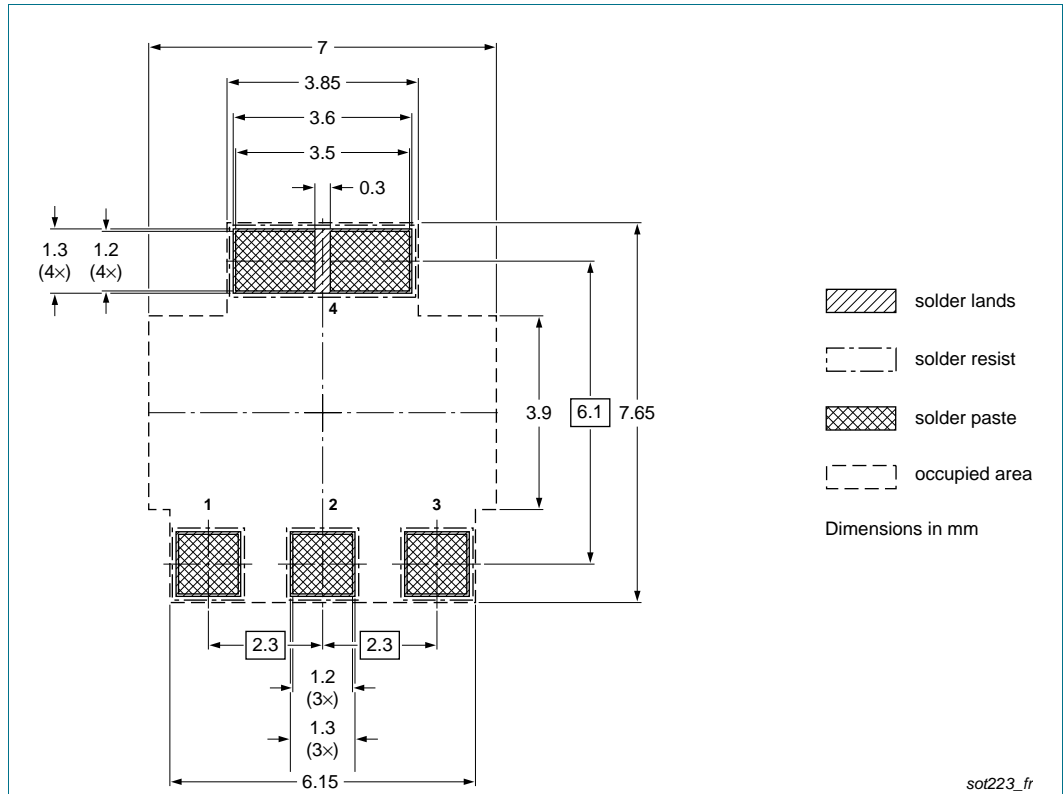


Fig 22. Reflow soldering footprint SOT223 (SC-73)

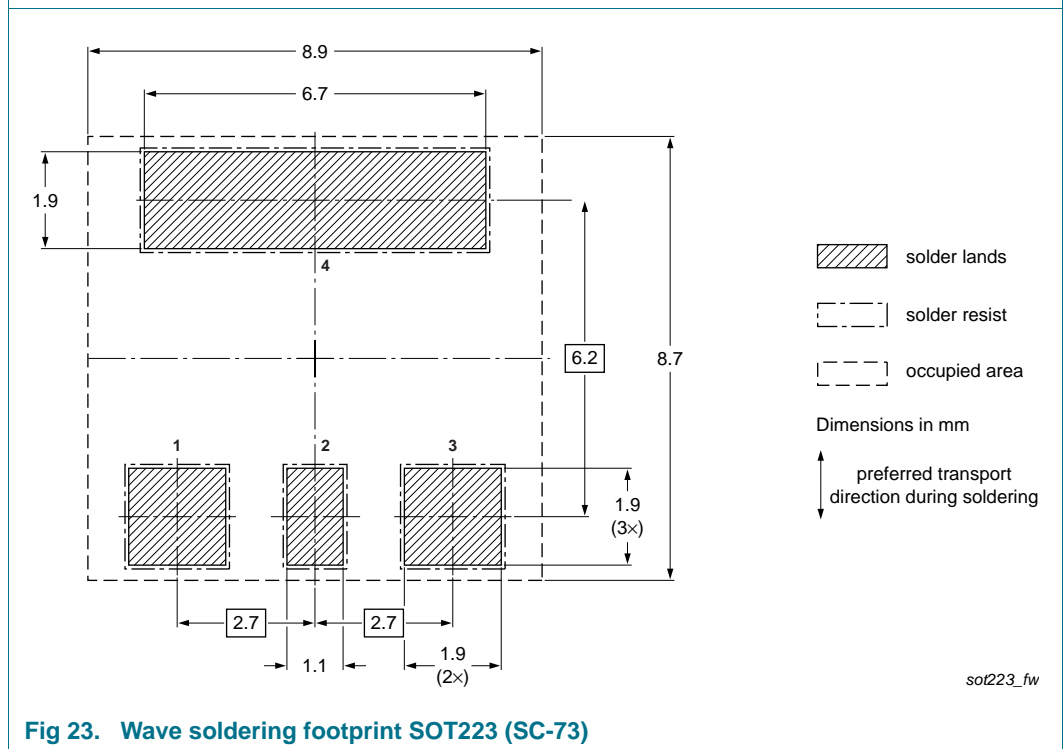


Fig 23. Wave soldering footprint SOT223 (SC-73)

12. Revision history

Table 10. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|---------------|---------------------------------------------------------|
| BCP51_BCX51_BC51PA v.9 | 20111013 | Product data sheet | - | BC636_BCP51_BCX51 v.8 |
| Modifications: | <ul style="list-style-type: none"> Deleted type number BC636 Added Type number BC51PA Section 1 "Product profile": updated Table 6 and 7: updated according to latest measurements Figure 1 to 9, 15, 17, 18 and 21: updated Figure 10 to 14: added Section 8 "Test information": added Section 11 "Soldering": added Section 13 "Legal information": updated | | | |
| BC636_BCP51_BCX51 v.8 | 20080222 | Product data sheet | - | BC636_BCP51_BCX51 v.7 |
| BC636_BCP51_BCX51 v.7 | 20070629 | Product data sheet | - | BC636_BCP51_BCX51 v.6 |
| BC636_BCP51_BCX51 v.6 | 20060329 | Product data sheet | - | BC636_638_640 v.5 BCP51_52_53 v.5 BCX51_52_53 v.4 |
| BC636_638_640 v.5 | 20041011 | Product specification | - | BC636_638_640 v.4 |
| BCP51_52_53 v.5 | 20030206 | Product specification | - | BCP51_52_53 v.4 |
| BCX51_52_53 v.4 | 20011010 | Product specification | - | BCX51_52_53 v.3 |

13. Legal information

13.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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For sales office addresses, please send an email to: salesaddresses@nexperia.com

15. Contents

| | | |
|-----------|------------------------------------------|-----------|
| 1 | Product profile | 1 |
| 1.1 | General description | 1 |
| 1.2 | Features and benefits | 1 |
| 1.3 | Applications | 1 |
| 1.4 | Quick reference data | 1 |
| 2 | Pinning information | 2 |
| 3 | Ordering information | 3 |
| 4 | Marking | 3 |
| 5 | Limiting values | 4 |
| 6 | Thermal characteristics | 6 |
| 7 | Characteristics | 12 |
| 8 | Test information | 14 |
| 8.1 | Quality information | 14 |
| 9 | Package outline | 14 |
| 10 | Packing information | 15 |
| 11 | Soldering | 16 |
| 12 | Revision history | 19 |
| 13 | Legal information | 20 |
| 13.1 | Data sheet status | 20 |
| 13.2 | Definitions | 20 |
| 13.3 | Disclaimers | 20 |
| 13.4 | Trademarks | 21 |
| 14 | Contact information | 21 |
| 15 | Contents | 22 |



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